

**Engineering Resin** 

## 3D Systems Figure 4® Hi-Temp 300-AMB

Ultra-high temperature plastic for use in applications requiring high heat resistance. With an HDT of over 300°C at both low and high stress (HDT at 0.455 and 1.82 MPa), this material is well suited for the testing of high temperature components. It does not require a secondary thermal post-cure.

## Features

- High-temperature resistant
- Translucent
- Impressive visualization properties
- No secondary thermal post-cure required
- Long term environmental UV and humidity stability

## Applications

- High temperature component testing
- General use parts
- Low pressure molding/tooling: expanding foams, rubbers, etc.
- Overmolding

Ultimate Tensile Strength 77 MPa

**Solid Part Density** 1.3 g/cc

**Tensile Modulus** 4100 MPa

**Elongation at Break** 2.3 %

Unnotched Izod Impact Strength 102 J/m

Shore Hardness 89 D



Technical Data Sheet



Safety Data Sheet